# onsemi

# **MOSFET** – Power, N-Channel, SUPERFET III, FRFET

V <sub>DSS</sub>	R <sub>DS(on)</sub> MAX	I <sub>D</sub> MAX
650 V	65 mΩ @ 10 V	46 A

## 650 V, 46 A, 65 m $\Omega$

## NTHL065N65S3F

### Description

SUPERFET III MOSFET is **onsemi**'s brand-new high voltage super-junction (SJ) MOSFET family that is utilizing charge balance technology for outstanding low on-resistance and lower gate charge performance. This advanced technology is tailored to minimize conduction loss, provide superior switching performance, and withstand extreme dv/dt rate.

Consequently, SUPERFET III MOSFET is very suitable for the various power system for miniaturization and higher efficiency.

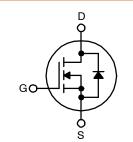
SUPERFET III FRFET MOSFET's optimized reverse recovery performance of body diode can remove additional component and improve system reliability.

## Features

- 700 V @ T<sub>J</sub> = 150°C
- Typ.  $R_{DS(on)} = 54 \text{ m}\Omega$
- Ultra Low Gate Charge (Typ. Q<sub>g</sub> = 98 nC)
- Low Effective Output Capacitance (Typ. Coss(eff.) = 876 pF)
- 100% Avalanche Tested
- This Device is Pb-Free and is RoHS Compliant

## Applications

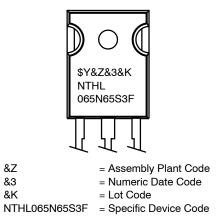
- Telecom / Server Power Supplies
- Industrial Power Supplies
- EV Charger
- USP / Solar





TO-247-3LD CASE 340CH

#### MARKING DIAGRAM



## ORDERING INFORMATION

See detailed ordering and shipping information on page 2 of this data sheet.

Symbol		NTHL065N65S3F	Unit V	
V <sub>DSS</sub>	Drain to Source Voltage			650
V <sub>GSS</sub>	Gate to Source Voltage	DC	±30	V
		AC (f > 1 Hz)	±30	
I <sub>D</sub> Drain Current	Drain Current	Continuous (T <sub>C</sub> = 25°C)	46	A
		Continuous (T <sub>C</sub> = 100°C)	30	
I <sub>DM</sub>	Drain Current	Pulsed (Note 1)	115	А
E <sub>AS</sub>	Single Pulsed Avalanche Energy (Note 2)		635	mJ
I <sub>AS</sub>	Avalanche Current (Note 2)		5.3	А
E <sub>AR</sub>	Repetitive Avalanche Energy (Note 1)		3.37	mJ
dv/dt	MOSFET dv/dt		100	V/ns
	Peak Diode Recovery dv/dt (Note 3)		50	
PD	Power Dissipation	$T_{\rm C} = 25^{\circ}{\rm C}$	337	W
		Derate Above 25°C	2.7	W/∘C
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Temperature Range		–55 to +150	°C
ΤL	Maximum Lead Temperature for Soldering, 1/8" from Case for 5 Sec- onds		300	°C

#### ABSOLUTE MAXIMUM RATINGS (T<sub>C</sub> = 25°C unless otherwise noted)

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected. 1. Repetitive rating: pulse-width limited by maximum junction temperature. 2.  $I_{AS} = 5.3 \text{ A}, R_G = 25 \Omega$ , starting  $T_J = 25^{\circ}C$ . 3.  $I_{SD} \le 23 \text{ A}, \text{ di/dt} \le 200 \text{ A/}\mu\text{s}, \text{ V}_{DD} \le 400 \text{ V}$ , starting  $T_J = 25^{\circ}C$ .

#### THERMAL CHARACTERISTICS

Symbol	Parameter	NTHL065N65S3F	Unit	
$R_{ extsf{ heta}JC}$	Thermal Resistance, Junction to Case, Max.	0.37	°C/W	
$R_{ hetaJA}$	Thermal Resistance, Junction to Ambient, Max.	40	°C/W	

#### PACKAGE MARKING AND ORDERING INFORMATION

Part Number	Top Mark	Package	Packing Method	Reel Size	Tape Width	Quantity
NTHL065N65S3F	NTHL065N65S3F	TO-247	Tube	N/A	N/A	30 Units

## **ELECTRICAL CHARACTERISTICS** ( $T_C = 25^{\circ}C$ unless otherwise noted)

Symbol	Parameter	Test Conditions	Min	Тур	Max	Unit
OFF CHARACT	ERISTICS					
BV <sub>DSS</sub>	Drain to Source Breakdown Voltage	$V_{GS}$ = 0 V, $I_D$ = 1 mA, $T_J$ = 25°C	650	-	-	V
		$V_{GS}$ = 0 V, $I_{D}$ = 1 mA, $T_{J}$ = 150°C	700	-	-	V
$\Delta \text{BV}_{\text{DSS}}  /  \Delta \text{T}_{\text{J}}$	Breakdown Voltage Temperature Coefficient	$I_D = 15 \text{ mA}$ , Referenced to $25^{\circ}\text{C}$	_	0.63	-	V/°C
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	$V_{DS} = 650 \text{ V}, V_{GS} = 0 \text{ V}$	-	-	10	μA
		$V_{DS}$ = 520 V, $T_{C}$ = 125°C	-	153	-	
I <sub>GSS</sub>	Gate to Body Leakage Current	$V_{GS}$ = ±30 V, $V_{DS}$ = 0 V	-	-	±100	nA
ON CHARACT	ERISTICS					
V <sub>GS(th)</sub>	Gate Threshold Voltage	$V_{GS} = V_{DS}, I_D = 1.3 \text{ mA}$	3.0	-	5.0	V
R <sub>DS(on)</sub>	Static Drain to Source On Resistance	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 23 A	-	54	65	mΩ
<b>9</b> FS	Forward Transconductance	V <sub>DS</sub> = 20 V, I <sub>D</sub> = 23 A	-	31	-	S
DYNAMIC CHA	RACTERISTICS					
C <sub>iss</sub>	Input Capacitance	V <sub>DS</sub> = 400 V, V <sub>GS</sub> = 0 V, f = 1 MHz	-	4075	-	pF
C <sub>oss</sub>	Output Capacitance		_	95	_	pF
C <sub>oss(eff.)</sub>	Effective Output Capacitance	$V_{DS}$ = 0 V to 400 V, $V_{GS}$ = 0 V	-	876	-	pF
C <sub>oss(er.)</sub>	Energy Related Output Capacitance	$V_{DS}$ = 0 V to 400 V, $V_{GS}$ = 0 V	_	160	-	pF
Q <sub>g(tot)</sub>	Total Gate Charge at 10V	$V_{DS}$ = 400 V, $I_{D}$ = 23 A, $V_{GS}$ = 10	-	98	-	nC
Q <sub>gs</sub>	Gate to Source Gate Charge	V (Note 4)	-	30	-	nC
Q <sub>gd</sub>	Gate to Drain "Miller" Charge		-	38	-	nC
ESR	Equivalent Series Resistance	f = 1 MHz	_	1.5	_	Ω
SWITCHING CH	HARACTERISTICS					
t <sub>d(on)</sub>	Turn-On Delay Time	$V_{DD} = 400 \text{ V}, \text{ I}_{D} = 23 \text{ A},$	_	34	-	ns
t <sub>r</sub>	Turn–On Rise Time	V <sub>GS</sub> = 10 V, R <sub>g</sub> = 2.7 Ω (Note 4)	_	31	-	ns
t <sub>d(off)</sub>	Turn-Off Delay Time		_	78	-	ns
t <sub>f</sub>	Turn-Off Fall Time		-	16	-	ns
SOURCE-DRA	IN DIODE CHARACTERISTICS					
I <sub>S</sub>	Maximum Continuous Source to Drain Diode Forward Current			-	46	Α
I <sub>SM</sub>	Maximum Pulsed Source to Drain Diode Forward Current			-	115	Α
V <sub>SD</sub>	Source to Drain Diode Forward Voltage	$V_{GS} = 0 \text{ V}, \text{ I}_{SD} = 23 \text{ A}$	-	-	1.3	V
t <sub>rr</sub>	Reverse Recovery Time	V <sub>GS</sub> = 0 V, I <sub>SD</sub> = 23 A,	-	116	-	ns
Q <sub>rr</sub>	Reverse Recovery Charge	dI <sub>F</sub> /dt = 100 A/µs	_	488	_	nC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 4. Essentially independent of operating temperature typical characteristics.

## **TYPICAL PERFORMANCE CHARACTERISTICS**

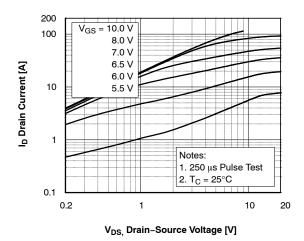
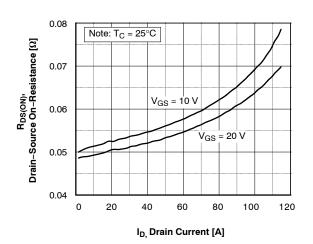
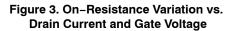


Figure 1. On-Region Characteristics





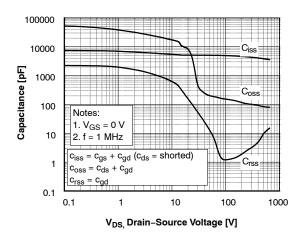
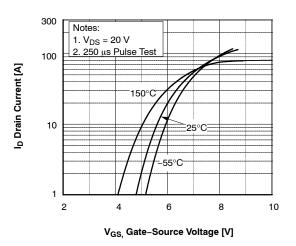
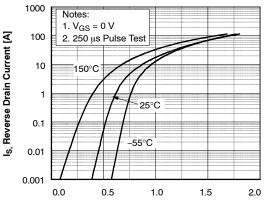


Figure 5. Capacitance Characteristics



**Figure 2. Transfer Characteristics** 



V<sub>SD,</sub> Body Diode Forward Voltage [V]

Figure 4. Body Diode Forward Voltage Variation vs. Source Current and Temperature

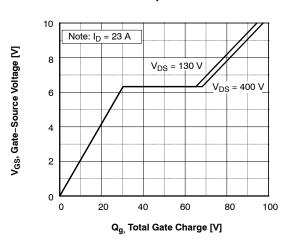
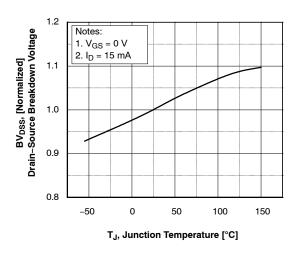


Figure 6. Gate Charge Characteristics

### TYPICAL PERFORMANCE CHARACTERISTICS (CONTINUED)





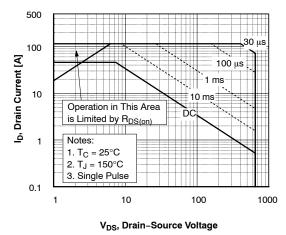


Figure 9. Maximum Safe Operating Area

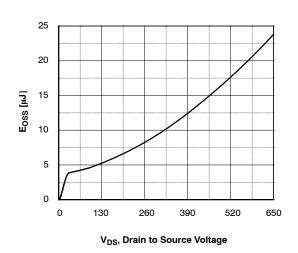


Figure 11. Eoss vs. Drain to Source Voltage

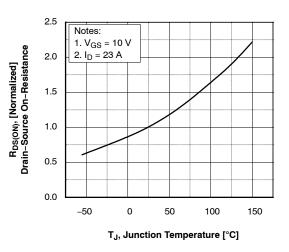


Figure 8. On–Resistance Variation vs. Temperature

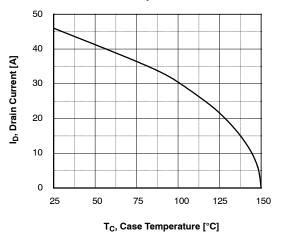


Figure 10. Maximum Drain Current vs. Case Temperature

## TYPICAL PERFORMANCE CHARACTERISTICS (CONTINUED)

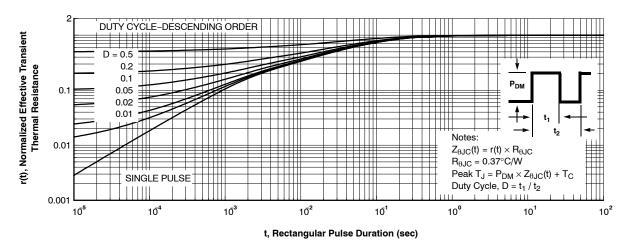
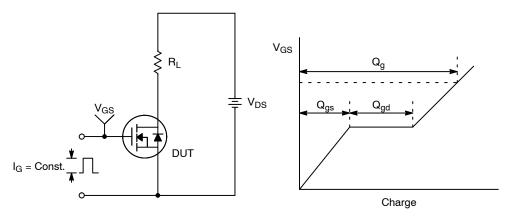


Figure 12. Transient Thermal Response Curve





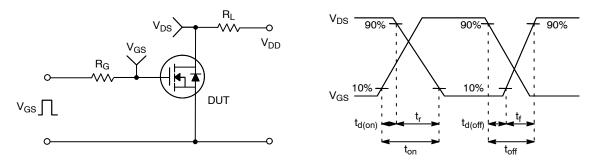


Figure 14. Resistive Switching Test Circuit & Waveforms

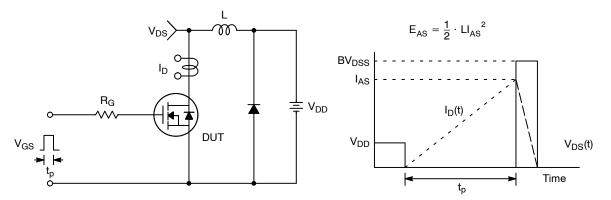


Figure 15. Unclamped Inductive Switching Test Circuit & Waveforms

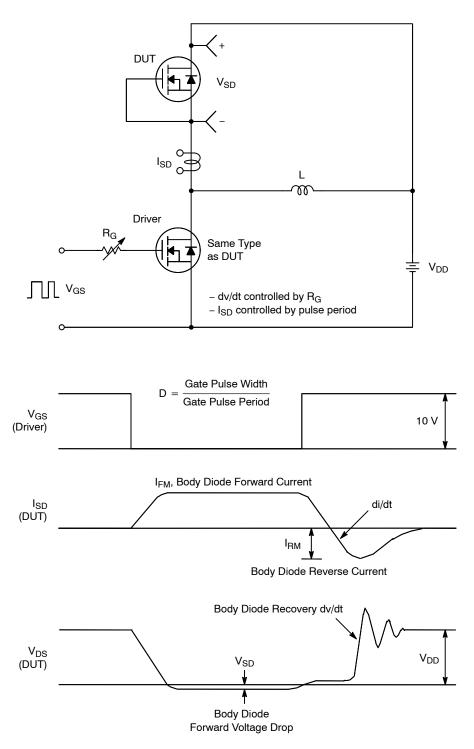


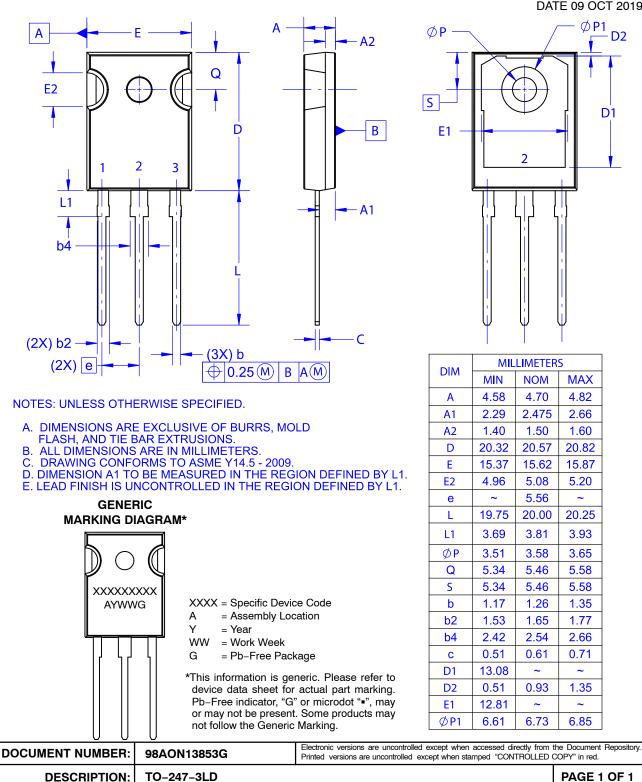
Figure 16. Peak Diode Recovery dv/dt Test Circuit & Waveforms

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